Single N-channel MOSFET

ELM14414AA-N

■ General description

ELM14414AA-N uses advanced trench technology to provide excellent Rds(on), low gate charge and low gate resistance.

Features

- Vds=30V
- Id=8.5A (Vgs=10V)
- Rds(on) $\leq 26 \text{m} \Omega$ (Vgs=10V)
- Rds(on) ≤ 40 m Ω (Vgs=4.5V)

■ Maximum absolute ratings

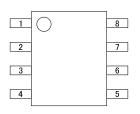
| Parameter | | Symbol | Limit | Unit | Note |
|--|---------|----------|------------|------------------------|------|
| Drain-source voltage | | Vds | 30 | V | |
| Gate-source voltage | | Vgs | ±20 | V | |
| Continuous drain current | Ta=25℃ | 1.1 | 8.5 | Δ | 1 |
| | Ta=70°C | Id | 7.1 | A | 1 |
| Pulsed drain current | | Idm | 50 | А | 2 |
| Power dissipation | Ta=25℃ | DI | 3.0 | 117 | |
| | Ta=70℃ | Pd | 2.1 | W | |
| Junction and storage temperature range | | Tj, Tstg | -55 to 150 | $^{\circ}\!\mathbb{C}$ | |

■ Thermal characteristics

| Parameter | | Symbol | Тур. | Max. | Unit | Note | |
|-----------------------------|--------------|--------|------|------|------|------|--|
| Maximum junction-to-ambient | t≤10s | Rθja | 31 | 40 | °C/W | 1 | |
| Maximum junction-to-ambient | Steady-state | Koja | 59 | 75 | °C/W |] 1 | |
| Maximum junction-to-lead | Steady-state | Rθil | 16 | 24 | °C/W | 3 | |

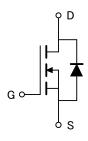
■Pin configuration

SOP-8 (TOP VIEW)



Pin No. Pin name 1 SOURCE 2 SOURCE 3 SOURCE 4 **GATE** 5 DRAIN 6 DRAIN 7 **DRAIN** 8 DRAIN

■Circuit



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■ Electrical characteristics

Ta=25°C

| Parameter | Symbol | Condition | | Min. | Тур. | Max. | Unit | |
|------------------------------------|---------|-----------------------------------|---------|------|-------|-------|------------|--|
| STATIC PARAMETERS | | | | | | | | |
| Drain-source breakdown voltage | BVdss | Id=250 μA, Vgs=0V | | 30 | | | V | |
| Zero gate voltage drain current | Idss | Vds=24V | | | 0.004 | 1.000 | | |
| | | Vgs=0V | Tj=55℃ | | | 5.000 | μΑ | |
| Gate-body leakage current | Igss | Vds=0V, Vgs=±20V | | | | 100 | nA | |
| Gate threshold voltage | Vgs(th) | Vds=Vgs, Id=250 μ A | | 1.0 | 1.9 | 3.0 | V | |
| On state drain current | Id(on) | Vgs=4.5V, Vds=5V | | 20 | | | Α | |
| Static drain-source on-resistance | Rds(on) | Vgs=10V | | | 20.0 | 26.0 | mΩ | |
| | | Id=8.5A | Tj=125℃ | | 29.2 | 38.0 | | |
| | | Vgs=4.5V, Id=5A | | | 31.0 | 40.0 | m Ω | |
| Forward transconductance | Gfs | Vds=5V, Id=5A | | 10 | 17 | | S | |
| Diode forward voltage | Vsd | Is=1A, Vgs=0V | | | 0.76 | 1.00 | V | |
| Max. body-diode continuous current | Is | | | | | 4.3 | Α | |
| DYNAMIC PARAMETERS | | | | | | | | |
| Input capacitance | Ciss | Vgs=0V, Vds=15V, f=1MHz | | | 680 | 820 | рF | |
| Output capacitance | Coss | | | | 102 | | рF | |
| Reverse transfer capacitance | Crss | | | | 77 | | рF | |
| Gate resistance | Rg | Vgs=0V, Vds=0V, f=1MHz | | | 3.0 | 3.6 | Ω | |
| SWITCHING PARAMETERS | | | | | | | | |
| Total gate charge(10V) | Qg | | | | 13.84 | 17.00 | пC | |
| Total gate charge(4.5V) | Qg | Vgs=10V, Vds=15V, Id=8.5A | | | 6.74 | 8.10 | nC | |
| Gate-source charge | Qgs | | | | 1.84 | | nC | |
| Gate-drain charge | Qgd | | | | 3.32 | | nC | |
| Turn-on delay time | td(on) | | | | 4.5 | 6.5 | ns | |
| Turn-on rise time | tr | Vgs=10V, Vds=15V | | | 4.2 | 6.3 | ns | |
| Turn-off delay time | td(off) | Rl=1.8 Ω , Rgen=3 Ω | | | 20.1 | 30.0 | ns | |
| Turn-off fall time | tf | | | | 4.9 | 7.5 | ns | |
| Body diode reverse recovery time | trr | If=8.5A, dl/dt=100A/ μ s | | | 17.2 | 21.0 | ns | |
| Body diode reverse recovery charge | Qrr | If=8.5A, dl/dt=100A/ μ s | | | 8.6 | 10.0 | пC | |

NOTE:

- 1. The value of $R\theta$ ja is measured with the device mounted on 1in^2 FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ themal resistance rating.
- 2. Repetitive rating, pulse width limited by junction temperature.
- 3. The $R\theta$ is the sum of the thermal impedance from junction to lead $R\theta$ and lead to ambient.
- 4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
- 5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.

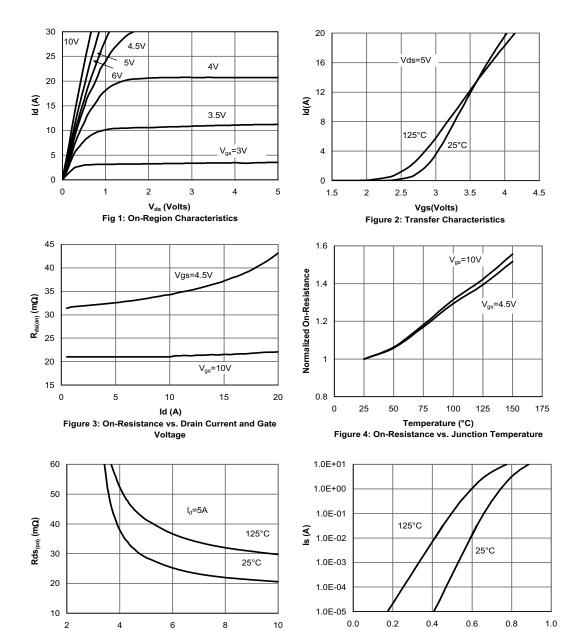


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■ Typical electrical and thermal characteristics

V_{gs} (Volts)

Figure 5: On-Resistance vs. Gate-Source Voltage





Vsd (Volts)

Figure 6: Body-Diode Characteristics

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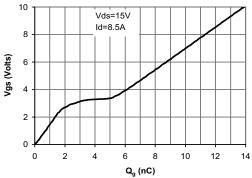


Figure 7: Gate-Charge Characteristics

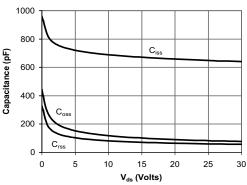


Figure 8: Capacitance Characteristics

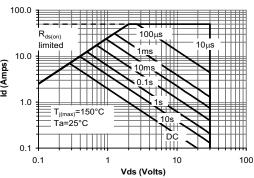


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

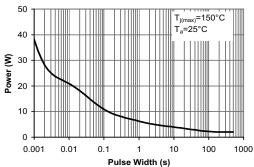


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

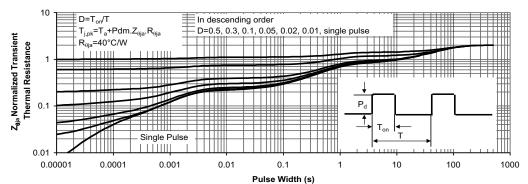


Figure 11: Normalized Maximum Transient Thermal Impedance



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